Hitachi Global Storage Technologies

Product summary Hitachi Deskstar 180GXP

Ultra ATA/100

Models: IC35L030AVV207

IC35L060AVV207 IC35L090AVV207 IC35L120AVV207 IC35L180AVV207



Introduction

The Hitachi Deskstar 180GXP is ideal for high performance desktop users. These drives feature capacities from 30 GB to 180 GB, a rotational speed of 7200 RPM, and average seek times of 8.2 and 8.5 ms. The Hitachi Deskstar 180GXP combines new and proven technologies to greatly enhance system performance and capacity.

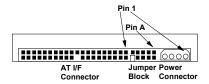
Applications

- Advanced desktop and audio/video
- Low-cost routers
- Switches
- Video editing

Features	Advantages
 Formatted capacities of 30, 40, 60, 80, 120, and 180 GB Rotational speed 7200 RPM 	 Supports higher quality digital audio/video storage, superior digital content creation capabilities, and significantly faster processing
 Ultra ATA/100 interface Self Diagnostics on Power On and resident diagnostics 	Optimizes system performance
Operating shock—No data loss occurs with a 55 G half-sine shock pulse of 2 ms duration	Protection for drive mishandlingIncreased reliability
 Idle power consumption of 6.7 Watts Circuits and motors optimized to save power and reduce system temperature 	Lower system power supply and cooling requirementsExtending system life and reliability
 2048 KB data buffer (8192 KB for some models) (upper 226.5 KB for firmware) Media-to-buffer transfer rates: 699 Mb/s (optimized 40GB model - 648 Mb/s) Average seek time: 8.5 ms (30 - 60 GB models), 8.2 ms (all other models) Average latency: 4.17 ms Complies with ATA6 specification 	Fast access to dataImproved throughput
 Fluid Dynamic Bearing and tri-laminate top cover reduce acoustics to 2.6 – 3.0 Bels (depending on model - see page 3) 	Lower acoustics

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Connectors



The DC power connector is designed to mate with AMP p/n 1-80424-0 using AMP strip pins (p/n 350078-4), loose piece pins (p/n 61173-4), or their equivalents.

Note: The AT signal connector is a 40-pin connector.

Cabling

The length of the cable from the host system to the drive must not exceed 18 inches.

For systems operating with Ultra DMA mode 3, 4, or 5, the 80-conductor ATA cable assembly must be used.

Jumper block

Jumper pin letter designations



A jumper attaches two pins together to configure the drive for the proper mode of operation.

Jumper settings

16 head logical architecture

Master active*	A-B and G-H
Slave active	A-B and C-D
Cable Select	A-B and E-F
Master/Slave present	E-F and G-H
Reserved	1

15 head logical architecture

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Master active	A-C and G-H
Slave active	A-C
Cable select	A-C and E-F
Master/Slave present	A-C, E-F & G-H
Reserved	1

All other jumper settings are reserved. Do not make other settings!

*Shipping default

DC power requirements

Damage to the drive electronics may result if the power supply cable is connected or disconnected while the power is on. There is no special power on/off sequencing required. The following voltage specification is applied at the power connector of the drive.

Input voltage (Volts)	During run and spin up (Volts)	Absolute max spike voltage
+5	5 ± 5%	7 ¹
+12	12 +10% -8%	15 ¹

¹Power supply voltage spikes in excess of the maximum values specified in the table may damage the drive electronics.

Power supply current

	mA RMS		Total
	+5 V	+12V	Watts
180 GB model			
Idle avg	280	470	7.0
Idle ripple – peak to peak	410	610	-
Seek peak	590	1950	_
Seek avg 1	330	690	10.0
Start up-max	740	1867	_
RND R/W peak	790	1800	-
RND R/W avg ²	490	660	10.3
Standby avg	140	20	0.9
Sleep avg	100	20	0.7

120 GB & 80 GB model

ldle avg	280	380	5.9
Idle ripple – p to p	410	490	_
Seek peak	590	1790	_
Seek avg 1	330	610	6.7
Start up-max	740	1800	_
RND R/W peak	1160	1790	
RND R/W avg ²	490	580	9.4
Standby avg	140	20	0.9
Sleen avg	100	20	0.7

60 GB - 30 GB model

60 GB – 30 GB model			
280	300	5.0	
430	410	-	
600	1550	-	
330	520	7.9	
730	1800	_	
1170	1550	_	
490	490	8.3	
140	20	0.9	
100	20	0.7	
	280 430 600 330 730 1170 490	280 300 430 410 600 1550 330 520 730 1800 1170 1550 490 490 140 20	

¹ Random seeks at 40% duty cycle

Power supply generated ripple

Output (V)	Maximum (mV p-p)	Freq. range (MHz)
+5	100	0–10
+12	150	0–10

Hot Plug/Unplug support

Hot plugging/unplugging is not allowed. Damage to the drive electronics may result if the power supply cable is connected or disconnected while power is being applied to the drive.

Data organization (logical)

Number of heads	16
Sectors/track	63
Number of cylinders	16,383

Model number	Total logical data
IC35L	bytes
030AVV207	30,738,677,760
060AVV207	41,174,138,880 &
000AVV207	61,492,838,400
090AVV207	82,348,277,760
120AVV207	123,522,416,640
180AVV207	185,283,624,960

Electromagnetic compatibility

When installed in a suitable enclosure and exercised with a random accessing routine at the maximum data rate the hard disk drive meets the following worldwide EMC requirements listed below:

- United States Federal Communications Commission (FCC) Rules and Regulations (Class B), Part 15.
- European Economic Community (EEC) directive number 76/889 related to the control of radio frequency interference and the Verband Deutscher Elektrotechniker (VDE) requirements of Germany (GOP).

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² Seek duty = 30%, W/R duty = 45%, Idle Duty = 25%

Environment	
Operating condition	ns
Temperature	5 to 55°C ¹
Relative humidity (noncondensing)	8 to 90%RH
Maximum wet bulb temperature (noncondensing)	29.4°C
Maximum tem- perature gradient	15°C/hour
Altitude	-300 to 3048 m

¹The system is responsible for providing sufficient air movement to maintain a surface temperature below 60°C at the center of the top cover of the drive.

Non operating conditions

Temperature	–40 to 65°C
Relative humidity	5 to 95%RH
(noncondensing)	3 10 9376KH
Maximum wet	
bulb temperature	35°C
(noncondensing)	
Altitude	-300 to 12,000m

Operating shock

The drive meets the following criteria while operating in respective conditions described in the list below.

- No error occurs with a 10 G halfsine shock pulse of 11 ms duration in all models.
- No data loss occurs with a 30 G half-sine shock pulse of 4 ms duration in all models.
- No data loss occurs with a 55 G half-sine shock pulse of 2 ms duration in all models.

The shock test consists of ten shocks inputs in each axis and in each direction for a total of 60. There must be a delay between shock pulses that is long enough to allow the drive to complete all of the necessary error recovery procedure.

Nonoperating shock

The drives will operate with no degradation of performance after being subjected to a shock pulses with the following characteristics. The tests involved trapezoidal and sinusoidal shock wave.

Trapezoidal shock wave

- The approximate shape of the pulse is square (trapezoidal).
- Approximate rise and fall time of pulse = 1 ms.
- Average acceleration level = 50 G. (Average response curve value during the time following the 1 ms rise time and before the 1 ms fall with a time duration of 11 ms)
- Minimum velocity change equals 4.23 m/s.

Sinusoidal shock wave

The shape is approximately a halfsine pulse. The following table shows the maximum acceleration level and duration.

	Acceler- ation level (G)	Duration (ms)
All models	75	11
180 GB	300	2
models	300	2
All other	350	2
models	330	2

Rotational shock

No data loss is incurred with the following rotational shocks applied around the axis of the actuator pivot:

- 30,000 rad/s² for a duration of 1 ms
- 20,000 rad/s² for a duration of 2 ms

Acoustics

The upper limit criteria of the octave sound power levels are given in Bels relative to one pico watt and are shown below. The measurement method is in accordance with ISO7779.

180 GB model

Mode	Typical (Bel)	Max. (Bel)
Idle	3.0	3.4
Operating		
Performance seek mode	3.4	3.7
Quiet seek mode	3.1	3.5

120 GB and 80 GB models

Mode	Typical (Bel)	Max. (Bel)
Idle	2.8	3.2
Operating		
Performance seek mode	3.4	3.7
Quiet seek mode	2.9	3.3

60 GB and 30 GB models

Mode	Typical (Bel)	Max. (Bel)
ldle	2.6	3.0
Operating		
Performance seek mode	3.4	3.7
Quiet seek mode	2.8	3.2



ATTENTION: The drive must be protected against electrostatic discharge especially when being handled. The safest way to

avoid damage is to put the drive in an anti-static bag before ESD wrist straps are removed.

Drives must be shipped in approved containers. Severe damage can be caused to the drive if the packaging does not adequately protect against the shock levels induced when a box is dropped. Consult your Hitachi Global Storage Technologies representative if you do not have an approved shipping container.

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Command descriptions

The following commands are supported by the drive:

Commands	(Hex)	<u>P</u>
Check Power Mode	E5	3
Check Power Mode*	98	3
Execute Device Diagnostic	90	3
Flush Cache	E7	3
Format Track	50	2
Identify Device	EC	1
Idle	E3	3
Idle*	97	3
Idle Immediate	E1	3
Idle Immediate*	95	3
Initialize Device		
Parameters	91	3
NOP	00	3
Read Buffer	E4	1
Read DMA (retry)	C8	4
Read DMA (no retry)	C9	4
Read DMA Queued	C7	5
Read Long (retry)	22	1
Read long (no retry)	23	1
Read Multiple	C4	1
Read Native Max	F8	3
Address	го	<u> </u>
Read Sectors (retry)	20	1
Read Sectors (no	21	1
retry)		
Read Verify Sectors	40	3
(retry)		
Read Verify Sectors	41	3
(no retry)	1x	2
Recalibrate Security Disable	IX	3
Password	F6	2
Security Erase		
Prepare	F3	3
Security Erase Unit	F4	2
Security Freeze Lock	F5	3
Security Set		
Password	F1	2
Security Unlock	F2	2
Seek	7x	
Service	A2	<u>3</u> 5
Set Features	EF	3
Set Max Address	F9	3
Set Multiple Mode	C6	3
Sleep	E6	3
Sleep*	99	3
SMART Disable	DΛ	3
Operations	B0	3
S.M.A.R.T. Enable/	<u>-</u>	
Disable Attribute Auto	B0	3
save		
S.M.A.R.T. Enable	В0	3
Operations C.M.A.B.T. Five-outs	-	
S.M.A.R.T. Execute Off-line Data	DΩ	2
Collection	B0	3
CONCOLION		

S.M.A.R.T. Read Attribute Values	В0	1
S.M.A.R.T. Read Attribute Thresholds	В0	1
S.M.A.R.T. Return Status	В0	3
S.M.A.R.T. Save Attribute Values	В0	3
S.M.A.R.T. Read Log Sector	В0	1
S.M.A.R.T. Write Log Sector	В0	2
S.M.A.R.T. Enable/ Disable Automatic Off-line Data Collection	В0	3
Standby	E2	3
Standby*	96	3
Standby Immediate	E0	3 3 3 2
Standby Immediate*	94	3
Write Buffer	E8	2
Write DMA (retry)	CA	4
Write DMA (no retry)	CB	4
Write DMA Queued	CC	5
Write Long (retry)	32	2
		2
Write Long (no retry)	33	
Write Long (no retry) Write Multiple	C5	2
Write Long (no retry)		2 2 2 2

Protocol

- 1 PIO data IN command
- 2 PIO data OUT command
- 3 Non data command
- 4 DMA command
- 5 DMA queued command
- + Vendor specific command

Note: Commands marked * are alternate command codes for previously defined commands

Signal definition					
Pin	Signal	I/O	Туре		
01	RESET-		(2)		
02	GND	-	_		
03	DD7	I/O	(1)		
04	DD8	I/O	(1)		
05	DD6	I/O	(1)		
06	DD9	I/O	(1)		
07	DD5	I/O	(1)		
08	DD10	I/O	(1)		
09	DD4	I/O	(1)		
10	DD11	I/O	(1)		
11	DD3	I/O	(1)		
12	DD12	I/O	(1)		
13	DD2	I/O	(1)		
14	DD13	I/O	(1)		
15	DD1	I/O	(1)		
16	DD14	I/O	(1)		
17	DD0	I/O	(1)		
18	DD15	I/O	(1)		
19	GND	_	_		
(20)	Key	_	_		
21	DMARQ	0	(1)		
22	GND	_	_		
23	DIOW-(**)		(2)		
24	GND	-	-		
25	DIOR-(**)	I	(2)		
26	GND	-	-		
27	IORDY(**)	0	(1)		
28	CSEL		(2)		
29	DMACK-		(2)		
30	GND	_	_		
31	INTRQ	0	(1)		
32					
33	DA1		(2)		
34	PDIAG-	I/O	(3)		
35	DA0		(2)		
36	DA2		(2)		
37	CS0-		(2) (2)		
38	CS1-		(2)		
39	DASP-	I/O	(3)		
40	GND	_	-		

Notes:

Type:

(1) 3-state

(2) TTL

(3) open-collector or open drain output

O – an output from the drive.

I - an input to the drive.

"I/O" designates an input/output common.

The signal lines marked with (**) are redefined during the Ultra DMA protocol to provide special functions. These lines change from the conventional to special definitions at the moment the Host decides to allow a DMA burst if the Ultra DMA transfer mode was previously chosen by means of SetFeatures. The Drive becomes aware of this change upon assertion of the DMACK—line. These lines revert back to their original definitions upon the deassertion of

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DMACK— at the termination of the DMA burst. See the table below.

Ultra DMA definitions

	Special definition (for Ultra DMA)	Conventional definition		
Write	DDMARDY- HSTROBE	IORDY DIOR-		
	STOP	DIOW-		
Pead	HDMARDY – DSTROBE	DIOR- IORDY		
Read	STOP	DIOW-		

Mechanical data	Μe	cha	anic	al d	ata
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Height	25.4 mm ± 0.4
Width	101.6 mm ± 0.4
Length	146.0 mm ± 0.6

Weight (maximum)	640 grams
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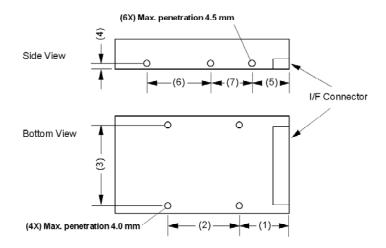
Mounting

The drive will operate in all axes (six directions). Performance and error rate will stay within specification limits if the drive is operated in the other permissible orientations from which it was formatted.

For reliable operation the drive must be mounted in the system securely enough to prevent damage from excessive motion or vibration during seek operation or spindle rotation, using appropriate screws or equivalent mounting hardware.

Drive level vibration test and shock test are to be conducted with the drive mounted to the table using the bottom four screws.

Mounting holes



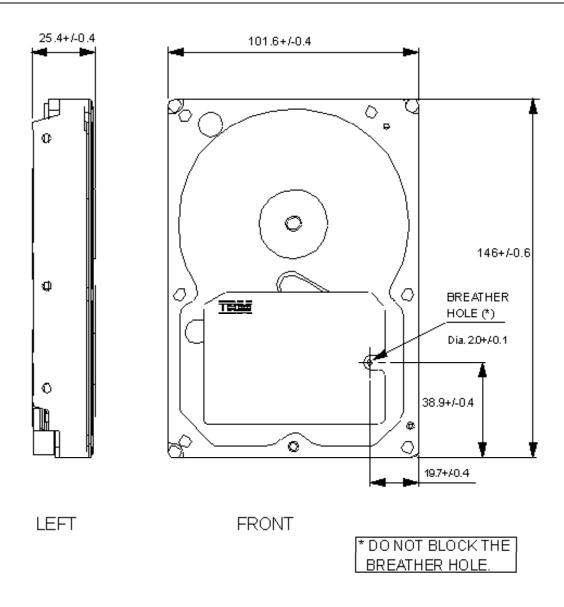
Dimension reference number	(1)	(2)	(3)	(4)	(5)	(6)	(7)
Dimension (mm)	41.28 ± 0.5	44.45 ± 0.2	95.25 ± 0.2	6.35 ± 0.2	28.5 ± 0.5	60.0 ± 0.2	41.6 ± 0.2

Mounting screw thread count = 6-32 UNC

Notes: Recommended screw torque to be applied to mounting screws is 0.6-1.0 Nm (6-10 kg-cm).

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Mechanical dimensions



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